

## P-Channel 30V (D-S) MOSFET

### GENERAL DESCRIPTION

The ME8117 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching and low in-line power loss are needed in a very small outline surface mount package.

### FEATURES

- $R_{DS(ON)} \leq 5.2\text{m}\Omega @ V_{GS} = -10\text{V}$
- $R_{DS(ON)} \leq 9.5\text{m}\Omega @ V_{GS} = -4\text{V}$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

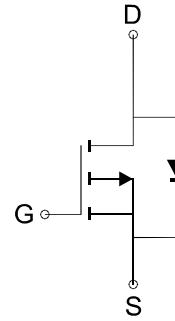
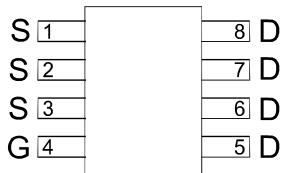
### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- LCD Display inverter

### PIN CONFIGURATION

(SOP-8)

Top View



P-Channel MOSFET

**Ordering Information:** ME8117(Pb-free)

ME8117-G (Green product-Halogen free)

### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter                               | Symbol          | Maximum Ratings | Unit |
|---|-----------------|-----------------|------|
| Drain-Source Voltage                    | $V_{DS}$        | -30             | V    |
| Gate-Source Voltage                     | $V_{GS}$        | $\pm 20$        | V    |
| Continuous Drain Current                | $I_D$           | -17.3           | A    |
|   |                 | -13.9           |      |
| Pulsed Drain Current                    | $I_{DM}$        | -69             | A    |
| Maximum Power Dissipation*              | $P_D$           | 2.5             | W    |
|   |                 | 1.6             |      |
| Junction and Storage Temperature Range  | $T_J, T_{STG}$  | -55 to 150      | °C   |
| Thermal Resistance-Junction to Ambient* | $R_{\theta JA}$ | 50              | °C/W |

\* The device mounted on 1in<sup>2</sup> FR4 board with 2 oz copper



**P-Channel 30V (D-S) MOSFET**
**Electrical Characteristics (T<sub>J</sub> = 25°C Unless Otherwise Specified)**

| Symbol                | Parameter                                     | Limit   | Min | Typ  | Max  | Unit |
|-----------------------|---|---|-----|------|------|------|
| <b>STATIC</b>         |   |   |     |      |      |      |
| V <sub>BR(DSS)</sub>  | Drain-source breakdown voltage                | I <sub>D</sub> =-10mA, V <sub>GS</sub> =0V  | -30 |      |      | V    |
| V <sub>GS(th)</sub>   | Gate Threshold Voltage                        | V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =-250 μA                               | -1  |      | -3.0 | V    |
| I <sub>GSS</sub>      | Gate Leakage Current                          | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V  |     |      | ±100 | nA   |
| I <sub>DSS</sub>      | Zero Gate Voltage Drain Current               | V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V  |     |      | -1   | μA   |
| R <sub>D(S(ON))</sub> | Drain-Source On-State Resistance <sup>a</sup> | V <sub>GS</sub> =-10V, I <sub>D</sub> = -9A   |     | 4    | 5.2  | mΩ   |
|                       |   | V <sub>GS</sub> =-4V, I <sub>D</sub> = -9A  |     | 7    | 9.5  |      |
| V <sub>SD</sub>       | Diode Forward Voltage                         | I <sub>D</sub> =-18A, V <sub>GS</sub> =0V   |     | -0.8 |      | V    |
| <b>DYNAMIC</b>        |   |   |     |      |      |      |
| Q <sub>g</sub>        | Total Gate Charge                             | V <sub>DD</sub> =-24V, V <sub>GS</sub> =-10V, I <sub>D</sub> =-18A                        |     | 146  |      | nC   |
| Q <sub>g</sub>        | Total Gate Charge                             | V <sub>DD</sub> =-24V, V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-18A                       |     | 78   |      |      |
| Q <sub>gs</sub>       | Gate-Source Charge                            |   |     | 24   |      |      |
| Q <sub>gd</sub>       | Gate-Drain Charge                             |   |     | 40   |      |      |
| C <sub>iss</sub>      | Input capacitance                             | V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz  |     | 6150 |      | pF   |
| C <sub>oss</sub>      | Output Capacitance                            |   |     | 950  |      |      |
| C <sub>rss</sub>      | Reverse Transfer Capacitance                  |   |     | 327  |      |      |
| t <sub>d(on)</sub>    | Turn-On Delay Time                            | V <sub>DD</sub> =-15V, R <sub>L</sub> =15Ω<br>V <sub>GS</sub> =-10V, R <sub>G</sub> =4.7Ω |     | 75   |      | ns   |
| t <sub>r</sub>        | Turn-On Rise Time                             |   |     | 32   |      |      |
| t <sub>d(off)</sub>   | Turn-Off Delay Time                           |   |     | 280  |      |      |
| t <sub>f</sub>        | Turn-Off Fall Time                            |   |     | 88   |      |      |

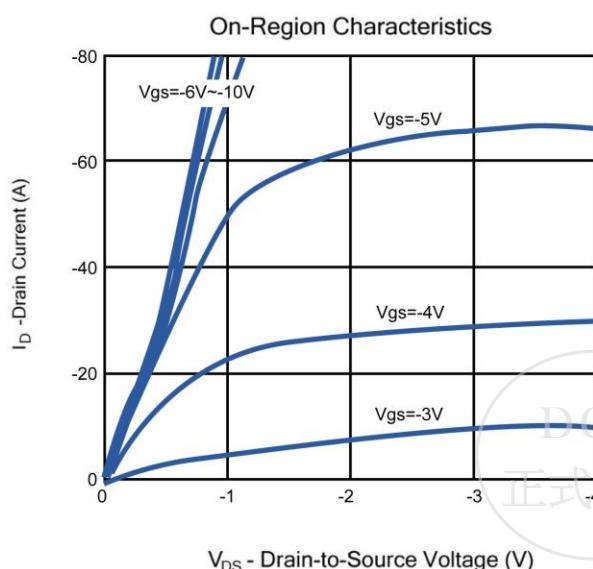
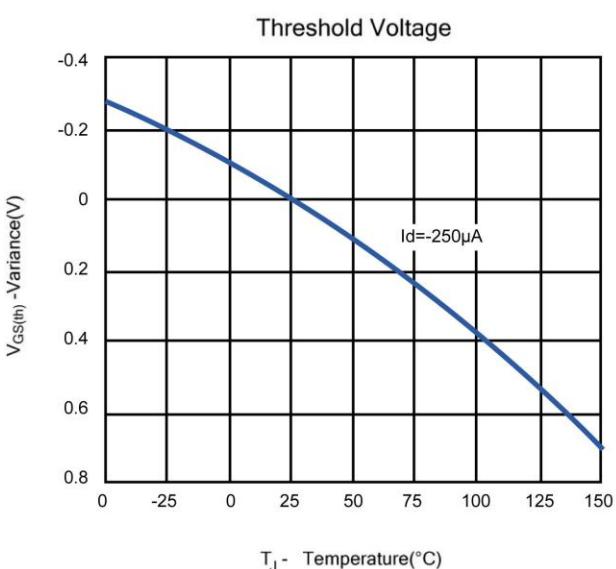
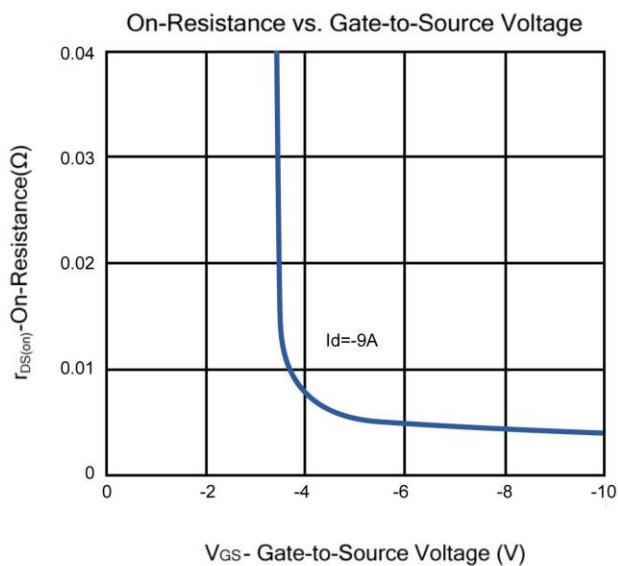
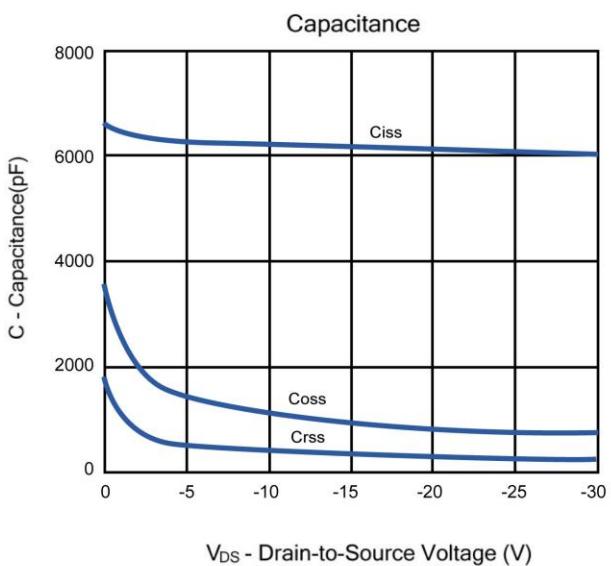
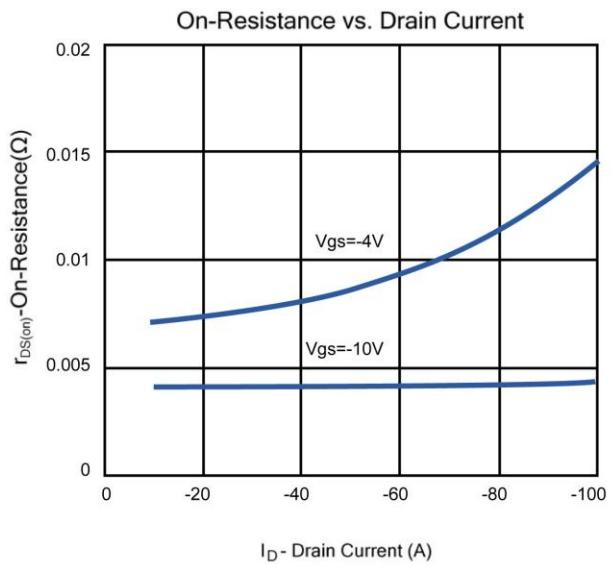
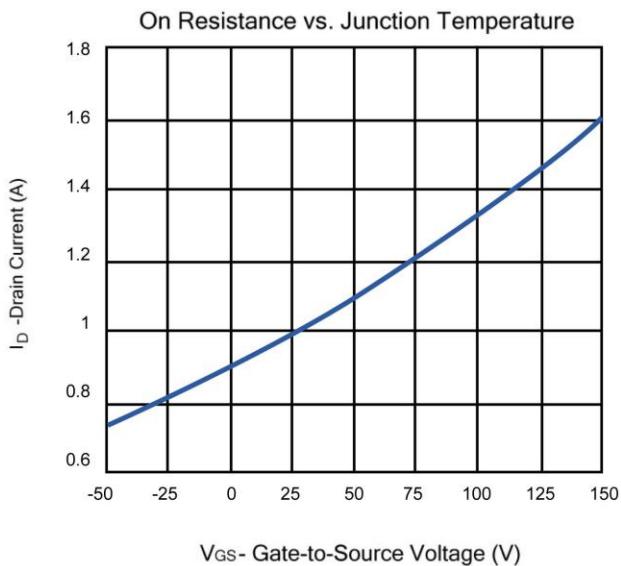
Notes:

- a. Pulse test: pulse width ≤ 300us, duty cycle ≤ 2%, Guaranteed by design, not subject to production testing.
- b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



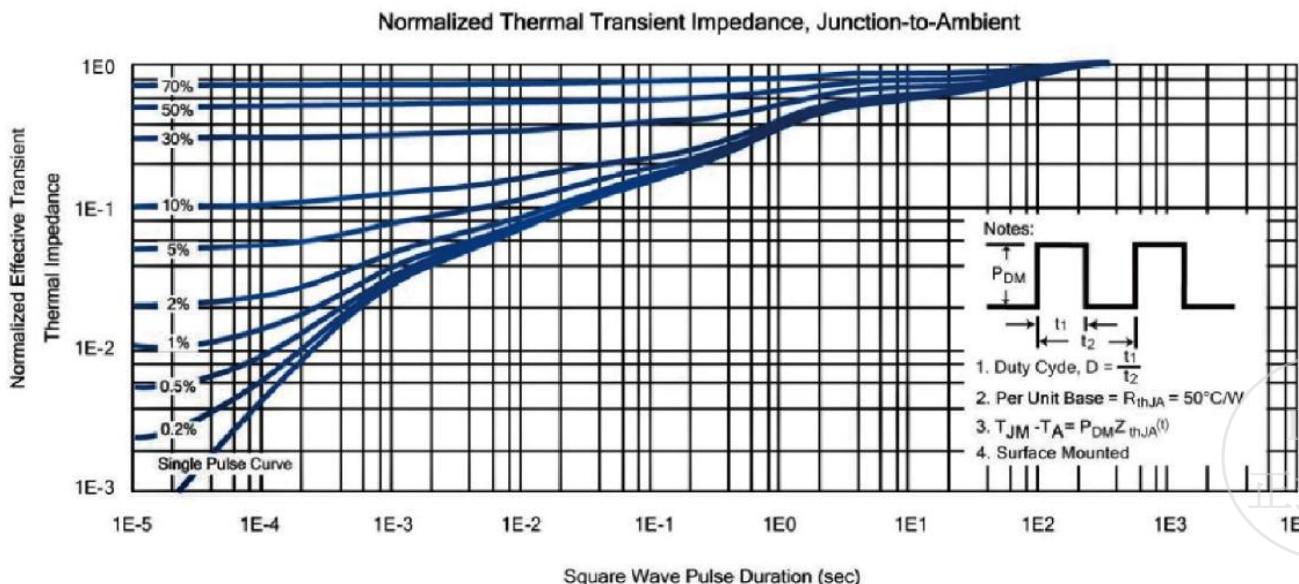
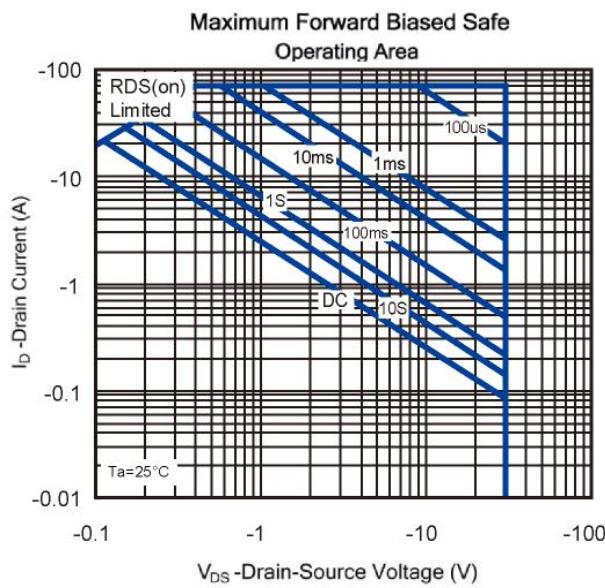
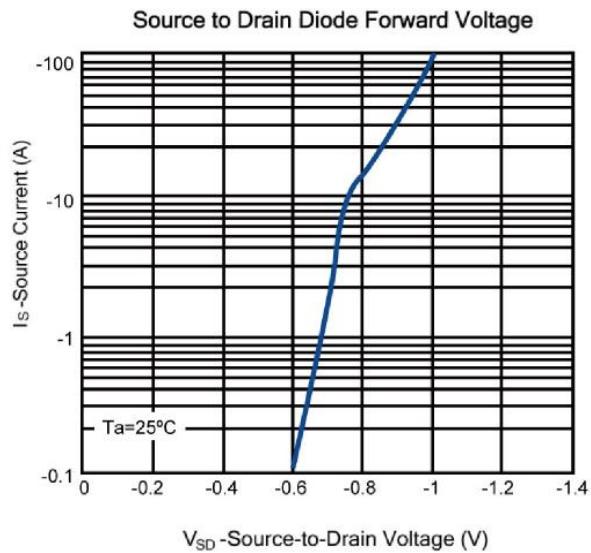
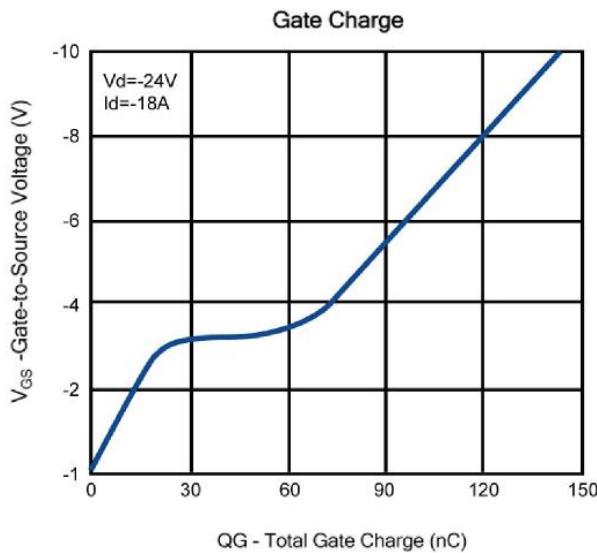
**P-Channel 30V (D-S) MOSFET**

**Typical Characteristics (T<sub>J</sub> =25°C Noted)**

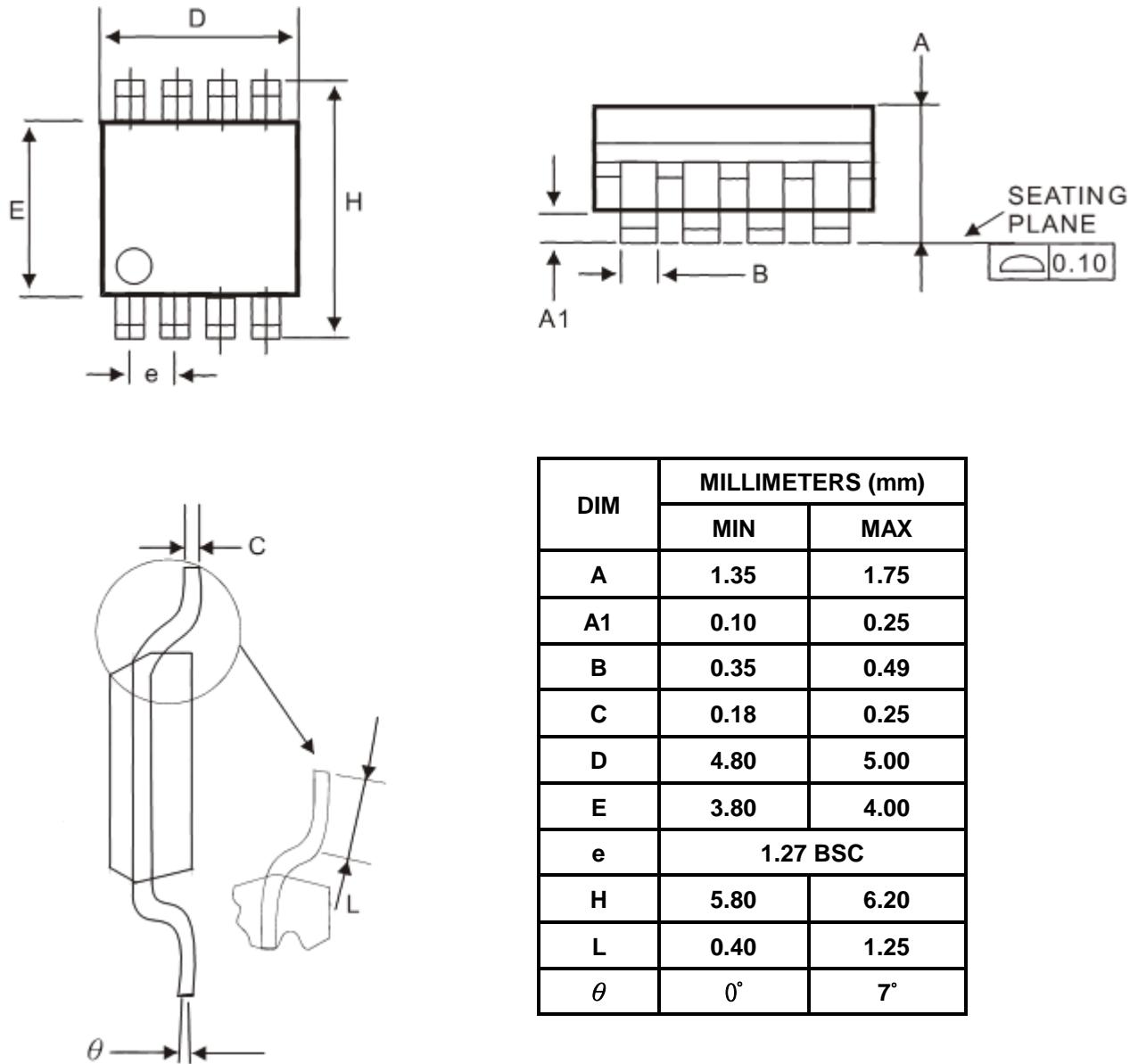


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Typical Characteristics ( $T_J = 25^\circ\text{C}$  Noted)



## SOP-8 Package Outline



- Note:
- Refer to JEDEC MS-012AA.
  - Dimension "D" does not include mold flash, protrusions or gate burrs . Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per side.

